

Title (en)

Substrate-free surface covering having coupling means

Title (de)

Substratfreie Oberflächenbedeckung mit Kopplungsmitteln

Title (fr)

Revêtement de surface sans substrat ayant des moyens de couplage

Publication

**EP 2644802 B1 20190828 (EN)**

Application

**EP 12161781 A 20120328**

Priority

EP 12161781 A 20120328

Abstract (en)

[origin: EP2644802A1] The present invention relates to a resilient substrate-free surface covering element comprising interlocking means to connect said resilient substrate-free surface covering element to another resilient substrate-free surface covering element.

IPC 8 full level

**E04F 15/10** (2006.01)

CPC (source: EP)

**E04F 15/105** (2013.01)

Citation (examination)

- US 2011167744 A1 20110714 - WHISPELL JOHN M [US], et al
- DE 202010013621 U1 20111228 - RAMPF GIESSHARZE GMBH & CO KG [DE]

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)

**EP 2644802 A1 20131002; EP 2644802 B1 20190828**; ES 2753171 T3 20200407; PL 2644802 T3 20200331

DOCDB simple family (application)

**EP 12161781 A 20120328**; ES 12161781 T 20120328; PL 12161781 T 20120328